

STGF4M65DF2

Trench gate field-stop IGBT, M series 650 V, 4 A low loss

Datasheet - production data

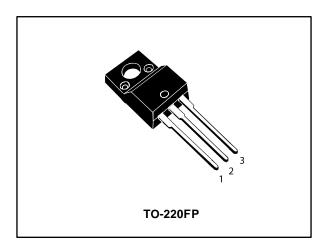
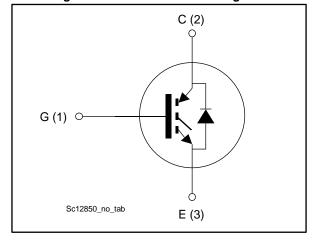


Figure 1: Internal schematic diagram



Features

- 6 µs of short-circuit withstand time
- V_{CE(sat)} = 1.6 V (typ.) @ I_C = 4 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGF4M65DF2	G4M65DF2	TO-220FP	Tube

Contents STGF4M65DF2

Contents

1 Electrical ratings					
2	Electric	cal characteristics	4		
	2.1	Electrical characteristics (curves)	6		
3	Test cir	cuits	11		
4	Packag	e information	12		
	4.1	TO-220FP package information	13		
5	Revisio	n history	15		

STGF4M65DF2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V _{GE} = 0 V)	650	V
Ic ⁽¹⁾	Continuous collector current at T _C = 25 °C	8	Α
IC(**	Continuous collector current at T _C = 100 °C	4	Α
Icp ⁽²⁾	Pulsed collector current	16	Α
V_{GE}	Gate-emitter voltage		V
l _F ⁽¹⁾	Continuous forward current at T _C = 25 °C	8	Α
IF ^(*)	Continuous forward current at T _C = 100 °C	4	Α
I _{FP} ⁽²⁾	Pulsed forward current		Α
Viso	V _{ISO} Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1s, TC= 25 °C)		kV
Ртот	P _{TOT} Total dissipation at T _C = 25 °C		W
Tstg	T _{STG} Storage temperature range		°C
TJ	T _J Operating junction temperature range -		°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{th} JC	Thermal resistance junction-case IGBT	6.5	°C/W
R _{th} JC	Thermal resistance junction-case diode	7	°C/W
R _{thJA}	Thermal resistance junction-ambient	62.5	°C/W

⁽¹⁾Limited by maximum junction temperature.

 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by maximum junction temperature.

Electrical characteristics STGF4M65DF2

2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_C = 250 \mu\text{A}$	650			V
		V _{GE} = 15 V, I _C = 4 A		1.6	2.1	
V _{CE(sat)}	V _{CE(sat)} Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 4 A, T _J = 125 °C		1.9		V
		V _{GE} = 15 V, I _C = 4 A, T _J = 175 °C		2.1		
		I _F = 4 A		1.9		
V_{F}	Forward on-voltage	I _F = 4 A, T _J = 125 °C		1.7		V
		I _F = 4 A, T _J = 175 °C		1.6		
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 250 \mu A$	5	6	7	V
I _{CES}	Collector cut-off current	V _{GE} = 0 V, V _{CE} = 650 V			25	μΑ
I _{GES}	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			±250	μA

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance			369	ı	
Coes	Output capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0 \text{ V}$	-	24.8	ı	pF
Cres	Reverse transfer capacitance	VGL — V	-	8	ı	
Qg	Total gate charge	Vcc = 520 V, Ic = 4 A,	-	15.2	ı	
Q_{ge}	Gate-emitter charge	V _{GE} = 15 V (see <i>Figure 30: " Gate</i>	-	3	-	nC
Qgc	Gate-collector charge	charge test circuit")	-	7	-	

STGF4M65DF2 Electrical characteristics

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time			12	-	ns
tr	Current rise time			6.9	-	ns
(di/dt)on	Turn-on current slope	V _{CE} = 400 V, I _C = 4 A,		480	-	A/µs
t _{d(off)}	Turn-off-delay time	$V_{GE} = 15 \text{ V}, R_G = 47 \Omega$		86	-	ns
t _f	Current fall time	(see Figure 29: "Test circuit for inductive load		120	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy	switching")		0.040	-	mJ
E _{off} (2)	Turn-off switching energy			0.136	-	mJ
Ets	Total switching energy			0.176	-	mJ
t _{d(on)}	Turn-on delay time			11.6	-	ns
tr	Current rise time			8	-	ns
(di/dt) _{on}	Turn-on current slope	VCE = 400 V, Ic = 4 A, VGE = 15 V, RG = 47 Ω , T _J = 175 °C (see Figure 29: " Test circuit for inductive load switching")		410	-	A/µs
t _{d(off)}	Turn-off-delay time			85	-	ns
t _f	Current fall time			211	-	ns
E _{on} (1)	Turn-on switching energy			0.067	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy			0.210	-	mJ
E _{ts}	Total switching energy			0.277	-	mJ
		V _{CC} ≤ 400 V, V _{GE} = 15 V, T _{Jstart} = 150 °C	6		-	μs
t _{sc}	Short-circuit withstand time	V _{CC} ≤ 400 V, V _{GE} = 13 V, T _{Jstart} = 150 °C	10		-	μs

Notes:

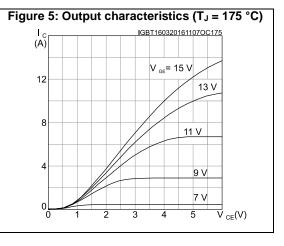
Table 7: Diode switching characteristics (inductive load)

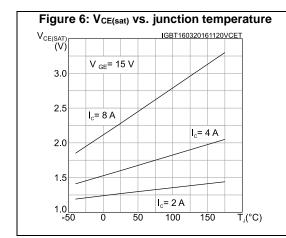
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time		ı	133	ı	ns
Q_{rr}	Reverse recovery charge	$I_F = 4 \text{ A}, V_R = 400 \text{ V},$	1	140	ı	nC
Irrm	Reverse recovery current	$V_{GE} = 15 \text{ V}, \text{ di/dt} = 800 \text{ A/}\mu\text{s}$	ı	5	1	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	(see Figure 29: " Test circuit for inductive load switching")	1	520	ı	A/µs
Err	Reverse recovery energy		1	15	1	μJ
t _{rr}	Reverse recovery time		-	236	-	ns
Qrr	Reverse recovery charge	I _F = 4 A, V _R = 400 V,	ı	370	ı	nC
I _{rrm}	Reverse recovery current	$V_{GE} = 15 \text{ V}, T_{J} = 175 \text{ °C},$ di/dt = 800 A/µs	1	6.6	1	Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	(see Figure 29: " Test circuit for inductive load switching")	1	378	1	A/µs
Err	Reverse recovery energy			32	-	μJ

⁽¹⁾Including the reverse recovery of the diode.

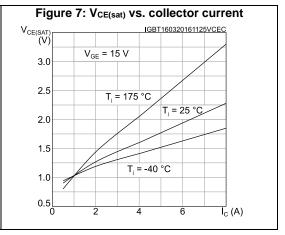
 $[\]ensuremath{^{(2)}}\mbox{Including}$ the tail of the collector current.

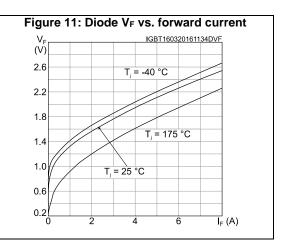
2.1 Electrical characteristics (curves)

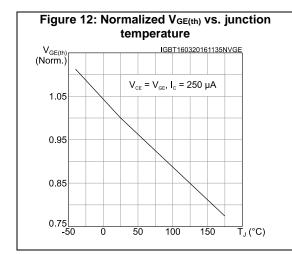




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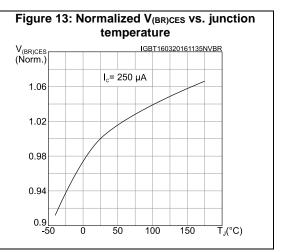
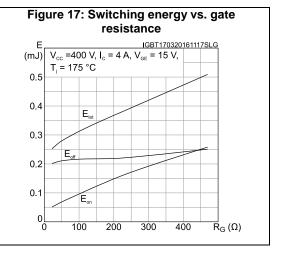
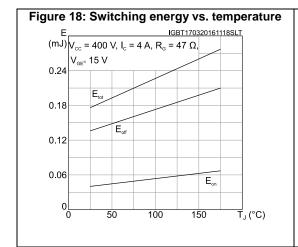
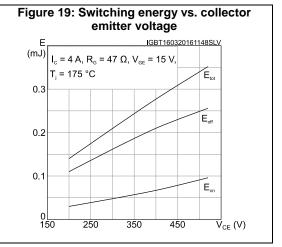


Figure 15: Gate charge vs. gate-emitter voltage

V_{GE} | IGBT160320161140GCGE |
(V) | V_{CC} = 520 V, I_C = 4 A, I_G = 1 mA |
15 | 12 | 9 |
6 | 3 |
0 | 3 | 6 | 9 | 12 | 15 | Q_g (nC)







STGF4M65DF2 Electrical characteristics

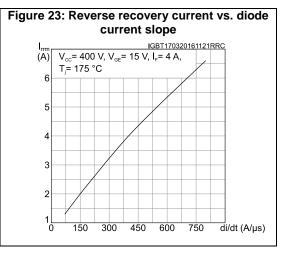
Figure 21: Switching times vs. collector current

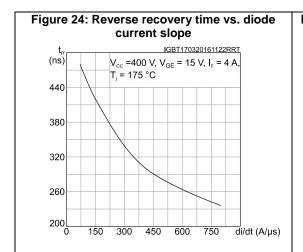
(ns) $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{OE} = 15 \text{ V}, R_{G} = 47 \Omega,$ $V_{CC} = 400 \text{ V}, V_{CC} = 400 \text{ V}, V_{CC$

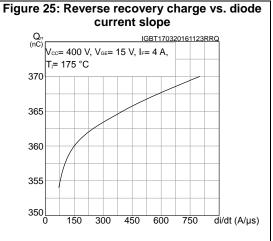
Figure 22: Switching times vs. gate resistance

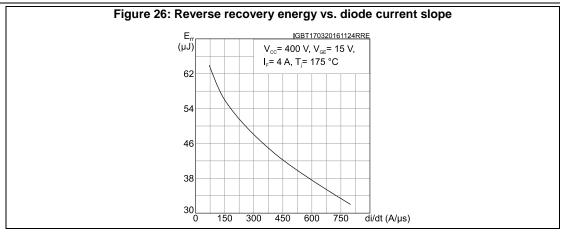
(ns) $V_{cc} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_{c} = 4 \text{ A},$ $T_{r} = 175 \text{ °C}$ 10² $t_{d(off)}$ 10⁰

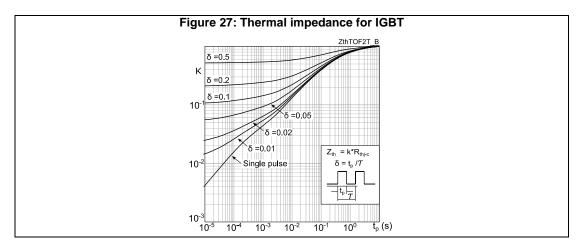
100 200 300 400 R_G (Ω)

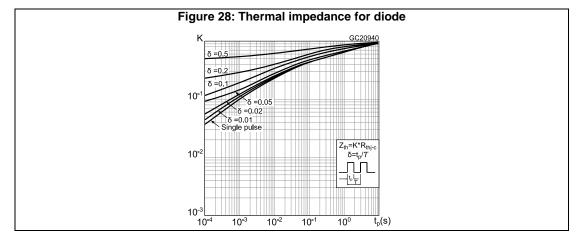






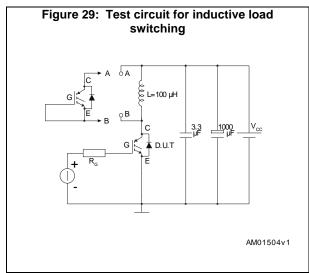


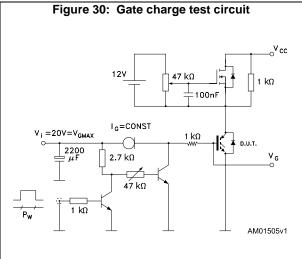


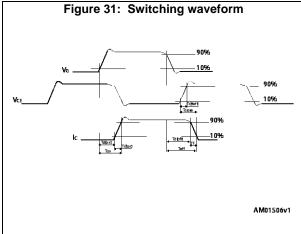


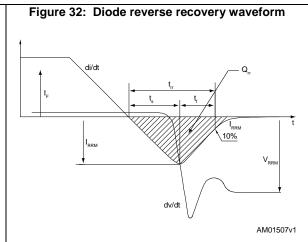
STGF4M65DF2 Test circuits

3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STGF4M65DF2 Package information

4.1 TO-220FP package information

Figure 33: TO-220FP package outline

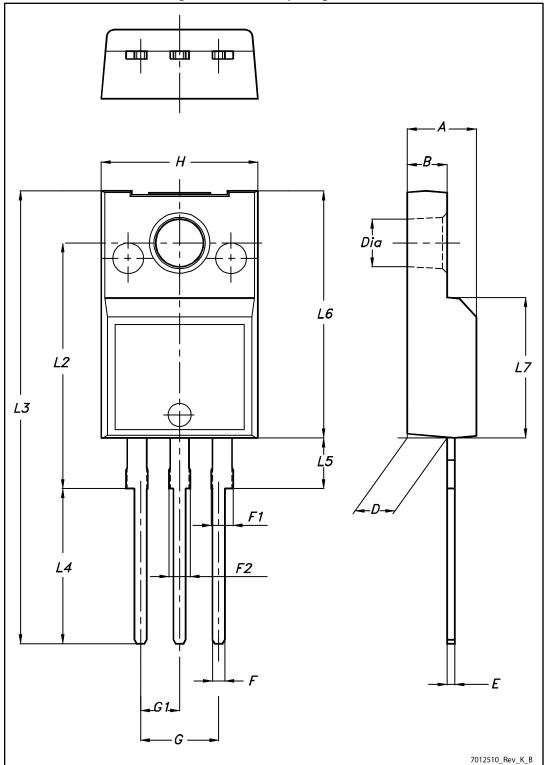


Table 8: TO-220FP package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

STGF4M65DF2 Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
25-Nov-2015	1	First release.
18-Apr-2016	2	Modified: features in cover page. Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)". Minor text changes
13-Jul-2016	3	Document status promoted from preliminary to production data.
21-Nov-2016	4	Updated Figure 1: "Internal schematic diagram" Updated Table 2: "Absolute maximum ratings" Updated Figure 25: "Reverse recovery charge vs. diode current slope" Minor text changes

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